

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of :
Akihisa HONGO et al. :
Serial No. NEW : Attn: Application Branch
Filed December 18, 2001 : Attorney Docket No. 2001-1846

SUBSTRATE PLATING METHOD AND
APPARATUS
(Rule 1.53(b) Divisional
of Serial No. 09/674,179,
Filed October 27, 2000)

PATENT OFFICE FEE TRANSMITTAL FORM

Assistant Commissioner for Patents,
Washington, DC 20231

Sir:

Attached hereto is a check in the amount of \$938.00 to cover Patent Office fees relating to filing the following attached papers:

Rule 53(b) application \$740.00

Additional Claims Fee:

Excess of Twenty \$198.00

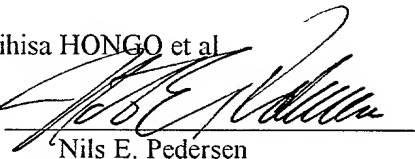
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The Commissioner is authorized to charge any deficiency or to credit any overpayment associated with this communication to Deposit Account No. 23-0975, with the EXCEPTION of deficiencies in fees for multiple dependent claims in new applications.

Respectfully submitted,

Akihisa HONGO et al

By



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THE COMMISSIONER IS AUTHORIZED
TO CHARGE ANY DEFICIENCY IN THE
FEES FOR THIS APPLICATION TO DEPOSIT
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